

09-19-2006



103308908

Docket No.: **applied 174**

SHEET

LY

U.S. Department of Commerce  
Patent and Trademark Office

To the Honorable Commr

attached original documents or copies thereof.

1. Name of conveying party(ies):

**Timothy Giorgetta**  
**Madjid Hamidi**

9-12-06

Additional name(s) of conveying party(ies) ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: **9/11/2006**

2. Name and address of receiving party(ies):

Name: **Applied Micro Circuits Corporation**

Internal Address:

Street Address: **6290 Sequence Drive**

City, State and ZIP: **San Diego, CA 92121**

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or registration number(s):

If this document is being filed together with a new application, the execution date of the application is:

**9/12/2006**

A. Patent Application No(s)

B. Patent No(s)

09/14/2006 MGE BREM1 00000025 11519549

04 FC:8021

40.00 DP

Additional numbers attached?

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Gerald W. Maliszewski**

Internal Address: **Registration No. 38,054**

Street Address: **P.O. Box 270829**

City, State and ZIP: **San Diego, CA 92198-2829**

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41) ..... \$ **40.00**

☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account

☐ Authorized to be charged to deposit account

8. Deposit Account number:

**502033**

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

**Gerald W. Maliszewski, Reg. # 38,054**

Name of Person Signing

Signature

Date

9/11/2006

Total number of pages including cover sheet, attachments, and document:

4

## ASSIGNMENT

WHEREAS, the undersigned Timothy Giorgetta and Madjid Hamidi, residents of San Diego, CA, (hereinafter termed "inventor") has invented certain new and useful improvements in:

### **SERIAL-TO-PARALLEL TRANSCEIVER WITH PROGRAMMABLE PARALLEL DATA PATH WIDTH**

and have executed a declaration or oath for an application for a United States patent disclosing and identifying the invention:

☒ On the 11th day of September, 2006;

Or

☐ Said application having been previously filed and assigned  
Serial Number            /           , and filing date           .

WHEREAS Applied Micro Circuits Corporation (AMCC), a corporation (hereinafter termed "Assignee"), having a place of business at 6290 Sequence Drive, San Diego, CA, 92121, wishes to acquire the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

1. Said Inventor does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any and all countries of the world for patents, certificates of inventions or other government grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications

treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said inventor shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting application for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

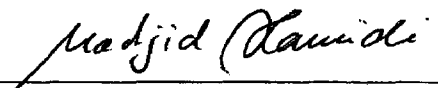
3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, said Inventor's heirs, legal representatives and assigns.

4. Said Inventor hereby warrants and represents that said Inventor has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventor has executed said Assignment on the date given below.

(1)   
(Timothy Giorgetta, Signature)

9/11/06  
(Date)

.....  
(2)   
(Madjid Hamidi, Signature)

9-11-06  
(Date)  
.....